ASSOCIATION CONNECTING ELECTRONICS INDUSTRIESS International and Pa	IPC. Bannockl	ourn. Illinois. A	Il rights reserved untions.	under both	This docume level parts, t	ent is a declaration en declaration	on of the su compasses	bstances v all lower	within the manufactur level materials for w	rer listed i hich the n	tem. Note:	if the item is an as r has engineering	sembly with low responsibility.	
				Form Type Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Material					ials and M	ls and Mfg Information			
Supplier Information														
Company name* Compan			pany unique ID			Unique ID Authority				Response Date*				
onsemi										2024-05-18				
ontact Name Title - Contact			ct				Phone - Contact*				Email - Contact*			
Product-Env-Stewards Product Env			nviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - Re			Representative			Phone - Representative*			Email - Representative*					
Product-Env-Stewards Pro			Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Requester Item Number	Requester Item Number Mfr Item		n Number Mfr Item Name			Effective Date	ate Version Manufacturing Site			Weight*	UOM	Unit Type		
	FDN302	FDN302P SSOT-3 PCH 20V		V		2024-05-18 MY1		IY1	10.53		mg	Each		
Aanufacturing Proccess Inform	ation							i						
Terminal Plating / Grid Array M	Iaterial 7	al Terminal Base Alloy J-S		J-STD-020 MSI	Rating	Peak Process Body Temperat		emperature	ure Max Time at Peak Tempera		ure Num	ber of Reflow Cyc	les	
Matte Tin (Sn) - annealed CU Alloy			1		260		С	30	secon	ids 3				
omments														
vel 1 - maximum time at peak temperat	ture during so	ldering is 10-3	0 seconds											
or more information regarding materia	l composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

sigma range of distribution unless otherwise noted).									
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure	
Die	0.766	mg	Supplier	Silicon (Si)	7440-21-3		0.766	mg	
Lead Frame	3.66	mg	Supplier	Zinc (Zn)	7440-66-6		0.0044	mg	
			Supplier	Iron (Fe)	7439-89-6		0.086	mg	
			Supplier	Copper (Cu)	7440-50-8		3.5685	mg	
			Supplier	Phosphorus (P)	7723-14-0		0.0011	mg	
Lead Frame plating	0.039	mg	Supplier	Silver (Ag)	7440-22-4		0.039	mg	
Mold Compound-Black	5.697	mg		Epoxy resin	proprietary data		0.2849	mg	
			Supplier	Phenolic Resin	Proprietary Data		0.2849	mg	
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.1139	mg	
			Supplier	Carbon Black (C)	1333-86-4		0.0285	mg	
			Supplier	Fused Silica (SiO2)	60676-86-0		4.9849	mg	
Plating	0.332	mg	Supplier	Tin (Sn)	7440-31-5		0.332	mg	
Wire Bond - Cu	0.036	mg	Supplier	Copper (Cu)	7440-50-8		0.036	mg	